IRFZ48

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_q (Max.) (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

0.018

60

110

29

36

Single

 $V_{GS} = 10 V$

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Ultra low on-resistance
- Very low thermal resistance
- 175 °C operating temperature
- Fast switching
- · Ease of paralleling
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFZ48PbF

ABSOLUTE MAXIMUM RATINGS (T_C	- 20°0, uni		sc noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	60	V	
Gate-source voltage			V _{GS}	± 20		
Continuous drain current	Vec et 10 V	T _C = 25 °C	- I _D	50		
Continuous drain current	V _{GS} at 10 V	T _C = 100 °C		50	A	
Pulsed drain current ^a			I _{DM}	290	1	
Linear derating factor				1.3	W/°C	
Single pulse avalanche energy ^b			E _{AS}	100	mJ	
Repetitive avalanche current ^a			I _{AR}	50	A	
Repetitive avalanche energy ^a			E _{AR}	19	mJ	
Maximum power dissipation	T _C =	25 °C	P _D	190	W	
Peak diode recovery dV/dt ^c			dV/dt	4.5	V/ns	
Operating junction and storage temperature range		T _J , T _{stg}	- 55 to + 175	- °C		
Soldering recommendations (peak temperature) ^d	For 10 s			300		
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting torque				1.1	N·m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 22 µH, R_g = 25 Ω I_{AS} = 72 A (see fig. 12)

c. $I_{SD} \le 72$ A, dl/dt ≤ 200 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C

d. 1.6 mm from case

e. Current limited by the package, (die current = 72 A)

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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		62					
Case-to-sink, flat, greased surface	R _{thCS}	0.50		-			°C/W		
Maximum junction-to-case (drain)	R _{thJC}	- 0.80							
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	nless otherwi	ise noted)							
PARAMETER	SYMBOL	TEST C	ONDITI	ONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 ¹	V, I _D = 2	50 µA	60	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to	o 25 °C,	I _D = 1 mA	-	0.060	-	V/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_G$	_{iS} , I _D = 2	50 µA	2.0	-	4.0	V	
Gate-source leakage	I _{GSS}	V _G	_S = ± 20		-	-	± 100	nA	
Zara gata valtaga drain avreat		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			-	-	25	μA	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$		-	-	250			
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	ار	_D = 43 A ^b	-	-	0.018	Ω	
Forward transconductance	9 _{fs}	V _{DS} = 25	5 V, I _D =	43 A ^b	27	-	-	S	
Dynamic									
Input capacitance	C _{iss}	Va	0 V		-	2400	-		
Output capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ - 1300 - f = 1.0 MHz see fig. 5				pF			
Reverse transfer capacitance	C _{rss}	f = 1.0 N	1Hz, see	fig. 5	-	190	-		
Total gate charge	Qg				-	-	110		
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$			-	-	29	nC	
Gate-drain charge	Q _{gd}		0001	ig. o ana ro	-	-	36		
Turn-on delay time	t _{d(on)}				-	8.1	-		
Rise time	t _r	V _{DD} = 30) V, I _D =	72 A,	-	250	-		
Turn-off delay time	t _{d(off)}	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $		-	ns				
Fall time	t _f			250	-	1			
Internal drain inductance	L _D	Between lead		nU					
Internal source inductance	Ls			-	— nH				
Drain-Source Body Diode Characteristic	s								
Continuous source-drain diode current	I _S	MOSFET symbol showing the			-	-	50 ^c	А	
Pulsed diode forward current ^a	I _{SM}	integral reverse p - n junction diode		-	-	290			
Body diode voltage	V_{SD}	T _J = 25 °C, I _S	= 72 A,	V _{GS} = 0 V ^b	-	-	2.0	V	
Body diode reverse recovery time	t _{rr}	T 25 °C 7	20 A 41/4	1 - 100 A (uch	-	120	180	ns	
Body diode reverse recovery charge	Q _{rr}	T _J = 25 °C, I _F = 7	∠ A, UI/0	$\mu t = 100 A/\mu s^3$	-	0.50	0.80	μC	
Forward turn-on time		Intrinsic turn-on time is negligible (turn							

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 $\,\%$

c. Current limited by the package, (die current = 72 A)

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

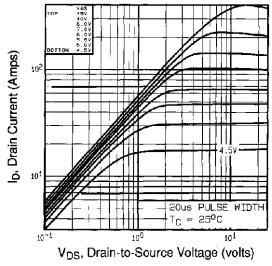


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

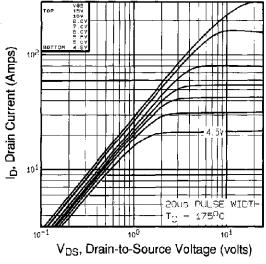
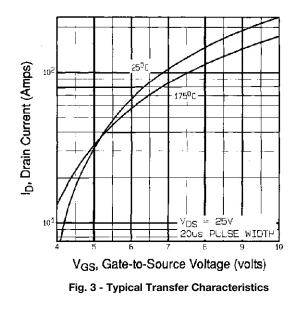


Fig. 2 - Typical Output Characteristics, $T_C = 175$ °C



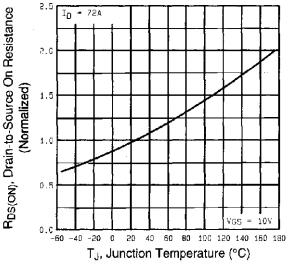


Fig. 4 - Normalized On-Resistance vs. Temperature

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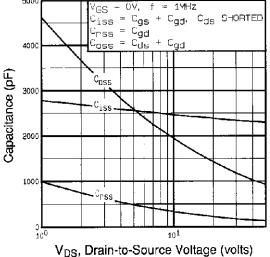


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

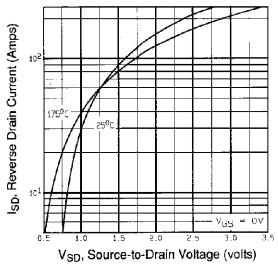


Fig. 7 - Typical Source-Drain Diode Forward Voltage

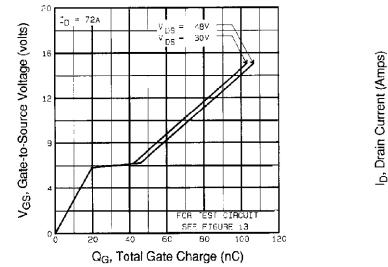
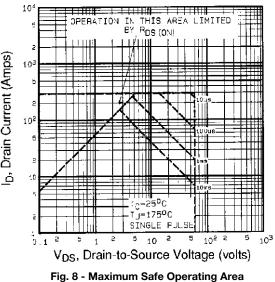


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





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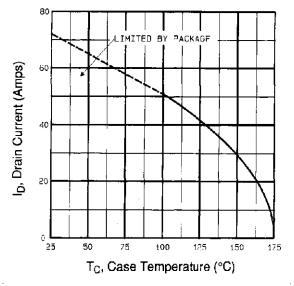


Fig. 9 - Maximum Drain Current vs. Case Temperature

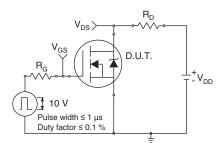


Fig. 10a - Switching Time Test Circuit

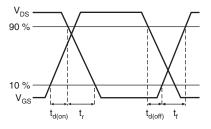


Fig. 10b - Switching Time Waveforms

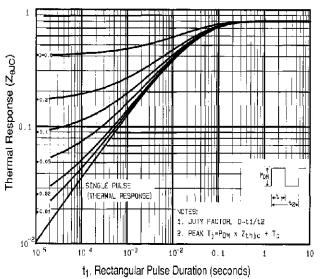


Fig. 10 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



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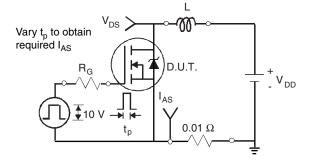


Fig. 12a - Unclamped Inductive Test Circuit

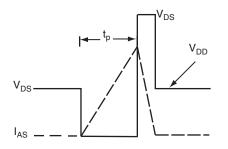


Fig. 12b - Unclamped Inductive Waveforms

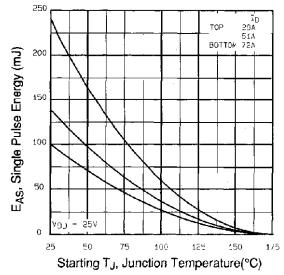


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

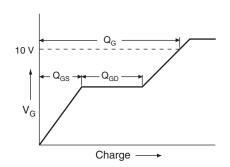


Fig. 13a - Basic Gate Charge Waveform

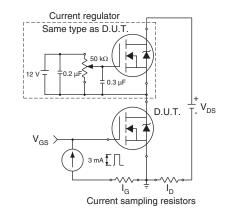
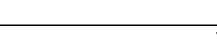


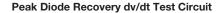
Fig. 13b - Gate Charge Test Circuit

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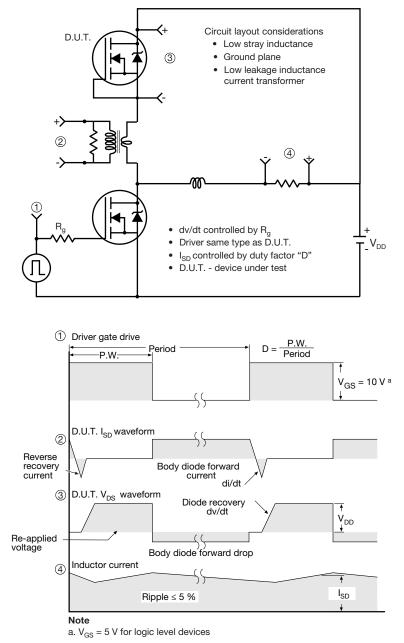


Fig. 14 - For N-Channel

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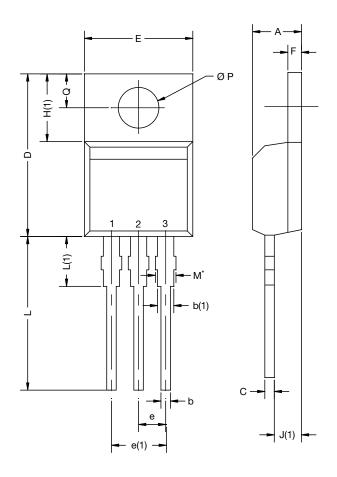
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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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